# G3VM-61G3 **MOS FET Relays**

## Ultrasensitive MOS FET Relay with Driving current 0.2 mA (maximum) in 60-V Load series.

• Continuous load current of 400 mA.

**RoHS compliant** 



Note: The actual product is marked differently from the image shown here.

## Application Examples

- Communication equipment
- Test & Measurement equipment
- Security equipment
- Amusement equipment
- Industrial equipment
- Various battery-driven devices

## ■ List of Models

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	<u> </u>	OMRON logo	H. Comre	<u>I</u> n	Mold pin mark *



Terminal Arrangement/Internal Connections

Note: The actual product is marked differently from the image shown here. \* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

Packago typo	Contact form	Terminals	Load voltage	Model	Minimum package quantity	
Fackage type	Contact Ionin	renninais	(peak value) *	Model	Number per tube	Number per tape and reel
SOP4	1a	Surface-mounting Terminals	60 V	G3VM-61G3	100	-
30F4	(SPST-NO)	Surface-mounting Terminals	00 V	G3VM-61G3 (TR)	-	2,500

\* The AC peak and DC value are given for the load voltage.

## ■ Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Rating	Unit	Measurement conditions	
	LED forward current	lF	30	mA		
Ħ	Repetitive peak LED forward current	IFP	1	А	100 µs pulses, 100 pps	
ndu	LED forward current reduction rate	∆IF/°C	-0.3	mA/°C	Ta≥25°C	
-	LED reverse voltage	VR	5	V		
	Connection temperature	TJ	125	°C		
	Load voltage (AC peak/DC)	Voff	60	V		
Ħ	Continuous load current (AC peak/DC)	lo	400	mA		
Outp	ON current reduction rate	∆lo/°C	-4.0	mA/°C	Ta≥25°C	
	Pulse ON current	IOP	1.2	А	t = 100 ms, Duty = 1/10	
	Connection temperature	TJ	125	°C		
Dielectric strength between I/O (See note 1.)		VI-0	1500	Vrms	AC for 1 min	Note: 1. The dielectric strength between the input and
Ambient operating temperature		Та	-40 to +85	°C	With no icing or condensation	output was checked by applying voltage
Ambient storage temperature		Tstg	-55 to +125	°C	With no icing or condensation	between all pins as a group on the LED side an
Soldering temperature		-	260	°C	10 s	all pins as a group on the light-receiving side.

## ■ Electrical Characteristics (Ta = 25°C)

ltem		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
	LED forward voltage	VF	1.1	1.27	1.4	V	IF = 10 mA
put	Reverse current	IR	-	-	10	μA	VR = 5 V
<u>n</u>	Capacity between terminals	Ст	-	30	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	-	-	0.2	mA	lo = 400 mA
Output	Maximum resistance with output ON	Ron	-	1	2	Ω	$I_F = 0.5 \text{ mA}, I_O = 400 \text{ mA}, t < 1 \text{ s}$
	Current leakage when the relay is open	ILEAK	-	1	1000	nA	Voff = 60 V
	Capacity between terminals	Coff	-	130	-	pF	V = 0, f = 1 MHz
Capacity between I/O terminals		CI-O	-	0.8	-	pF	f = 1 MHz, Vs = 0 V
Insulation resistance between I/O terminals		Ri-o	1000	-	-	MΩ	VI-0 = 500 VDC, RoH $\leq$ 60 %
Turn-ON time		ton	-	3.5	10	ms	$I_F = 0.5 \text{ mA}, \text{ RL} = 200 \Omega,$
Turn-OFF time		toff	-	1	5	ms	VDD = 20 V (See note 2.)



## Note: 2. Turn-ON and Turn-OFF Times



# G3VM-61G3

#### **MOS FET Relays**

### Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	Vdd	-	-	48	V
Operating LED forward current	lF	-	0.5	25	mA
Continuous load current (AC peak/DC)	lo	-	-	320	mA
Ambient operating temperature	Та	-20	-	65	°C

#### Engineering Data



lo - Ta 500 Continuous load current lo (mA) 400 300 200 100 0 60 -40 20 40 80 100 -20 0 Ambient temperature Ta (°C)

Continuous load current vs. Ambient temperature

#### LED forward current vs. LED forward voltage





Continuous load current vs. On-state voltage On-state resistance vs. Ambient temperature



Trigger LED forward current vs. Ambient temperature



Turn ON, Turn OFF time vs. LED forward current Turn ON, Turn OFF time vs. Ambient temperature Current leakage vs. Ambient temperature







#### ■ Safety Precautions

• Refer to "Common Precautions" for all G3VM models.







#### ■ Appearance

#### SOP (Small Outline Package)



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#### Dimensions

(Unit: mm)



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Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product. Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperty. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

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